

AON3814-VB Datasheet Dual N-Channel 20 V (D-S) MOSFET

| PRODUC | T SUMMARY | | |
|---------------------|-----------------------------------|--------------------|-----------------------|
| V _{DS} (V) | R _{DS(on)} (Ω) | I _D (A) | Q _g (TYP.) |
| | 0.0170 at V _{GS} = 4.5 V | 20 | |
| 20 | 0.0240 at V _{GS} = 2.5 V | 17 | 12 nC |
| | 0.0490 at V _{GS} = 1.8 V | 10 | |

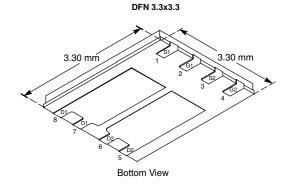
FEATURES

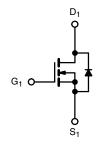
• Trench power MOSFET

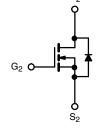
APPLICATIONS

- DC/DC
- Notebook system power
- POL









N-Channel MOSFET

N-Channel MOSFET

| PARAMETER | SYMBOL | LIMIT | UNIT | | |
|--|------------------------|-----------------------------------|---------------------|-----|--|
| Drain-Source Voltage | | V _{DS} | 20 | V | |
| Gate-Source Voltage | | V _{GS} | ± 8 | | |
| | T _C = 25 °C | | 20 | | |
| Continues Durin Comment /T 150 °C) | T _C = 70 °C | | 15.8 | | |
| Continuous Drain Current (T _J = 150 °C) | T _A = 25 °C | I _D | 8 a, b | | |
| | T _A = 70 °C | | 6.5 ^{a, b} | | |
| Pulsed Drain Current | | I _{DM} | 40 | Α | |
| Outline and Outline Bright Outline | T _C = 25 °C | | 15 | | |
| Continuous Source-Drain Diode Current | T _A = 25 °C | l _s | 2.2 ^{a, b} | | |
| Single Pulse Avalanche Current | | I _{AS} | 15 | | |
| Single Pulse Avalanche Energy L = 0.1 mH | | E _{AS} | 11 | mJ | |
| | T _C = 25 °C | | 20 | | |
| Martin or Brown Black of the | T _C = 70 °C | | 12.8 | 10/ | |
| Maximum Power Dissipation | T _A = 25 °C | P _D | 2.5 ^{a, b} | W | |
| | T _A = 70 °C | | 1.6 ^{a, b} | | |
| Operating Junction and Storage Temperature Range | | T _J , T _{stg} | -55 to +150 | 00 | |
| Soldering Recommendations (Peak Temperature) c, d | | | 260 | °C | |

| THERMAL RESISTANCE RATINGS | | | | | | |
|----------------------------------|--------------|-------------------|---------|---------|------|--|
| PARAMETER | | SYMBOL | TYPICAL | MAXIMUM | UNIT | |
| Maximum Junction-to-Ambient | t ≤ 10 s | R _{thJA} | 38 | 48 | °C/W | |
| Maximum Junction-to-Case (Drain) | Steady State | R_{thJC} | 4.3 | 5.4 | C/VV | |

Notes

- a. Package limited, T_C = 25 °C.
- b. Surface Mounted on 1" x 1" FR4 board.
- c. t = 10 s
- d. Maximum under Steady State conditions is 110 °C/W.

服务热线:400-655-8788

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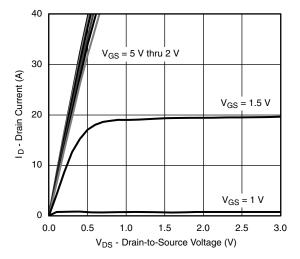
| PARAMETER | SYMBOL | TEST CONDITIONS | MIN. | TYP. | MAX. | UNIT |
|---|--|--|------|--------|-------|---------|
| Static | | | | | I. | |
| Drain-Source Breakdown Voltage | urce Breakdown Voltage V _{DS} | | 20 | - | - | V |
| V _{DS} Temperature Coefficient | $\Delta V_{DS}/T_{J}$ | L 050 A | - | 22 | - | mV/°C |
| V _{GS(th)} Temperature Coefficient | $\Delta V_{GS(th)}/T_J$ | $I_D = 250 \mu A$ | - | -3 | - | |
| Gate-Source Threshold Voltage | | | 0.4 | - | 1 | V |
| Gate-Source Leakage | I _{GSS} | $V_{DS} = 0 \text{ V}, V_{GS} = \pm 8 \text{ V}$ | - | - | ± 100 | nA |
| Zono Coto Voltogo Duoin Current | | V _{DS} = 20 V, V _{GS} = 0 V | - | - | 1 | μΑ |
| Zero Gate Voltage Drain Current | IDSS | V _{DS} = 20 V, V _{GS} = 0 V, T _J = 55 °C | - | - | 10 | |
| On-State Drain Current ^a | I _{D(on)} | $V_{DS} \ge 5 \text{ V}, V_{GS} = 10 \text{ V}$ | 20 | - | - | Α |
| | | $V_{GS} = 4.5 \text{ V}, I_D = 10 \text{ A}$ | - | 0.0170 | - | Ω |
| Drain-Source On-State Resistance ^a | R _{DS(on)} | V _{GS} = 2.5 V, I _D = 9 A | - | 0.0240 | - | |
| | ` , | $V_{GS} = 1.8 \text{ V}, I_D = 8.2 \text{ A}$ | - | 0.0490 | - | |
| Forward Transconductance a | 9fs | V _{DS} = 10 V, I _D = 10 A | - | 47 | - | S |
| Dynamic ^b | | | • | | | |
| Input Capacitance | C _{iss} | | - | 1120 | - | |
| Output Capacitance | Coss | $V_{DS} = 10 \text{ V}, V_{GS} = 0 \text{ V}, f = 1 \text{ MHz}$ | - | 180 | - | pF |
| Reverse Transfer Capacitance | C _{rss} | | | 80 | - | 1 |
| Tabal Oata Obaasa | | $V_{DS} = 15 \text{ V}, V_{GS} = 8 \text{ V}, I_D = 10 \text{ A}$ | - | 21 | 32 | nC |
| Total Gate Charge | Qg | | - | 12 | 18 | |
| Gate-Source Charge | Q _{gs} | $V_{DS} = 15 \text{ V}, V_{GS} = 4.5 \text{ V}, I_D = 10 \text{ A}$ | - | 2 | - | |
| Gate-Drain Charge | Q _{gd} | | - | 1.3 | - | |
| Gate Resistance | Rg | f = 1 MHz | - | 1.8 | 3.6 | Ω |
| Turn-On Delay Time | t _{d(on)} | | - | 10 | 15 | |
| Rise Time | t _r | $V_{DD} = 10 \text{ V}, R_{I} = 1.25 \Omega$ | - | 10 | 15 | |
| Turn-Off Delay Time | t _{d(off)} | $I_D \cong 8 \text{ A}, V_{GEN} = 4.5 \text{ V}, R_g = 1 \Omega$ | - | 35 | 55 | |
| Fall Time | t _f | | - | 10 | 15 | |
| Turn-On Delay Time | t _{d(on)} | | - | 10 | 15 | ns - |
| Rise Time | t _r | $V_{DD} = 10 \text{ V}, R_L = 1.25 \Omega$ | - | 10 | 15 | |
| Turn-Off Delay Time | t _{d(off)} | $I_D \cong 8 \text{ A}, V_{GEN} = 8 \text{ V}, R_g = 1 \Omega$ | - | 25 | 40 | |
| Fall Time | t _f | | - | 10 | 15 | |
| Drain-Source Body Diode Characteristic | cs | | | | | |
| Continuous Source-Drain Diode Current | I _S | T _C = 25 °C | - | - | 19 | |
| Pulse Diode Forward Current I _{SM} | | | - | - | 40 | A |
| Body Diode Voltage | V _{SD} | I _S = 8 A, V _{GS} = 0 V | - | 0.81 | 1.2 | V |
| Body Diode Reverse Recovery Time | t _{rr} | | - | 20 | 30 | ns |
| Body Diode Reverse Recovery Charge | Q _{rr} | L 0.4 JU/JU 400.4/ T 07.50 | - | 15 | 25 | nC |
| Reverse Recovery Fall Time | t _a | $I_F = 8 \text{ A}, \text{ dI/dt} = 100 \text{ A/}\mu\text{s}, T_J = 25 °\text{C}$ | - | 12.5 | - | |
| Reverse Recovery Rise Time | t _b | | _ | 7.5 | - | ns |

Notes

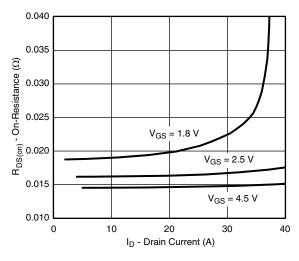
- a. Pulse test; pulse width \leq 300 μ s, duty cycle \leq 2 %
- b. Guaranteed by design, not subject to production testing.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

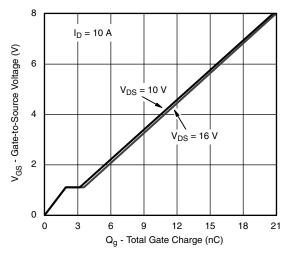




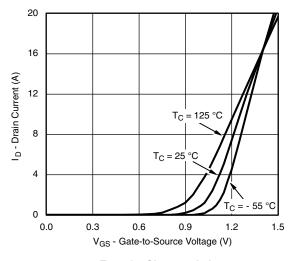
Output Characteristics



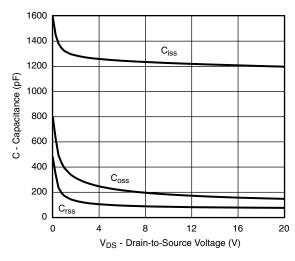
On-Resistance vs. Drain Current and Gate Voltage



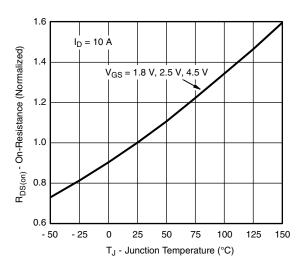
Gate Charge



Transfer Characteristics

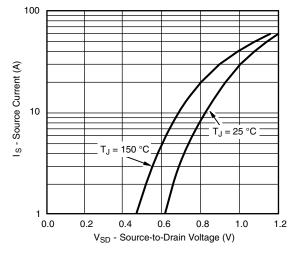


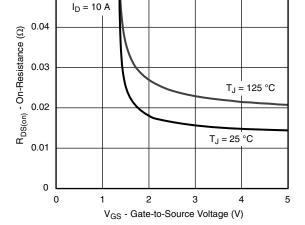
Capacitance



On-Resistance vs. Junction Temperature



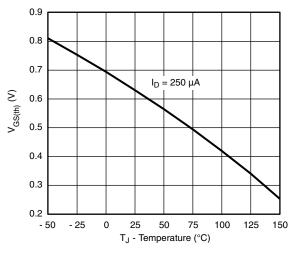


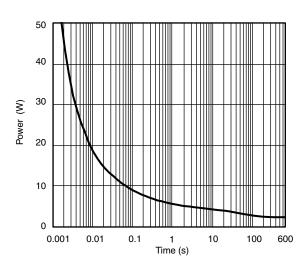


0.05

Source-Drain Diode Forward Voltage

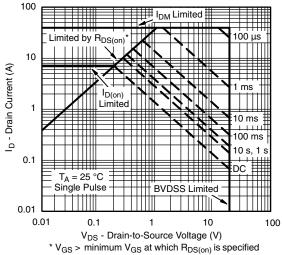






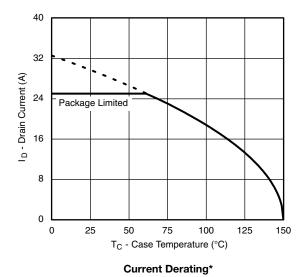
Threshold Voltage

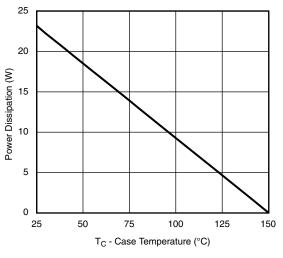
Single Pulse Power, Junction-to-Ambient



Safe Operating Area, Junction-to-Ambient



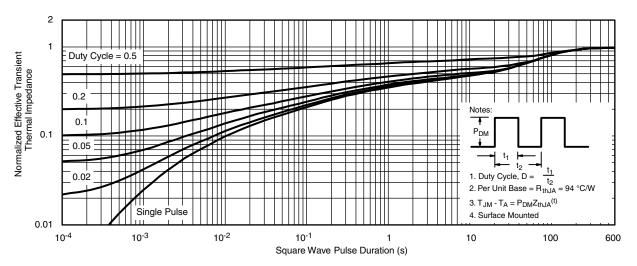




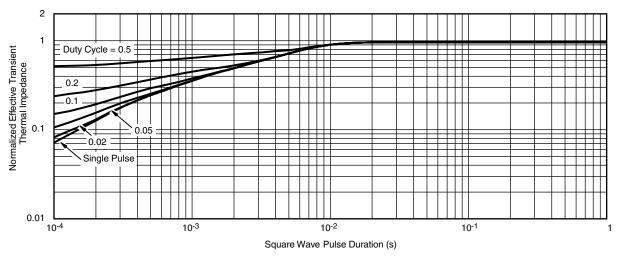
Power Derating

 $^{^*}$ The power dissipation P_D is based on T_J (max.) = 150 $^{\circ}$ C, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit.





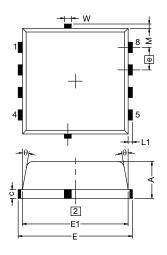
Normalized Thermal Transient Impedance, Junction-to-Ambient

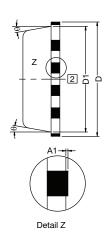


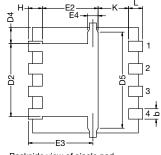
Normalized Thermal Transient Impedance, Junction-to-Case



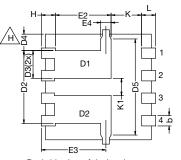
DFN3.3X3.3 (Dual)







Backside view of single pad



Backside view of dual pad

Notes
1. Inch will govern
2 Dimensions exclusive of mold gate burrs
3. Dimensions exclusive of mold flash and cutting burrs

| DIM | MILLIMETERS | | | INCHES | | | |
|------|-------------|----------|------|------------|------------|-------|--|
| DIM. | MIN. | NOM. | MAX. | MIN. | NOM. | MAX. | |
| Α | 0.97 | 1.04 | 1.12 | 0.038 | 0.041 | 0.044 | |
| A1 | 0.00 | - | 0.05 | 0.000 | - | 0.002 | |
| b | 0.23 | 0.30 | 0.41 | 0.009 | 0.012 | 0.016 | |
| С | 0.23 | 0.28 | 0.33 | 0.009 | 0.011 | 0.013 | |
| D | 3.20 | 3.30 | 3.40 | 0.126 | 0.130 | 0.134 | |
| D1 | 2.95 | 3.05 | 3.15 | 0.116 | 0.120 | 0.124 | |
| D2 | 1.98 | 2.11 | 2.24 | 0.078 | 0.083 | 0.088 | |
| D3 | 0.48 | - | 0.89 | 0.019 | - | 0.035 | |
| D4 | 0.47 typ. | | | 0.0185 typ | | | |
| D5 | | 2.3 typ. | | | 0.090 typ | | |
| E | 3.20 | 3.30 | 3.40 | 0.126 | 0.130 | 0.134 | |
| E1 | 2.95 | 3.05 | 3.15 | 0.116 | 0.120 | 0.124 | |
| E2 | 1.47 | 1.60 | 1.73 | 0.058 | 0.063 | 0.068 | |
| E3 | 1.75 | 1.85 | 1.98 | 0.069 | 0.073 | 0.078 | |
| E4 | 0.034 typ. | | | 0.013 typ. | | | |
| е | | 0.65 BSC | | | 0.026 BSC | | |
| K | 0.86 typ. | | | 0.034 typ. | | | |
| K1 | 0.35 | - | - | 0.014 | = | - | |
| Н | 0.30 | 0.41 | 0.51 | 0.012 | 0.016 | 0.020 | |
| L | 0.30 | 0.43 | 0.56 | 0.012 | 0.017 | 0.022 | |
| L1 | 0.06 | 0.13 | 0.20 | 0.002 | 0.005 | 0.008 | |
| θ | 0° | - | 12° | 0° | - | 12° | |
| W | 0.15 | 0.25 | 0.36 | 0.006 | 0.010 | 0.014 | |
| М | 0.125 typ. | | | | 0.005 typ. | • | |

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